

26V Transient Voltage Suppressor

Features

- 6000 Watts Peak Power ($t_p = 8/20\mu s$)
- Fast Response time: Typically $<1ns$
- Excellent Clamping Capability
- Low Inductance
- Low profile package

IEC COMPATIBILITY (EN61000-4)

- IEC 61000-4-2 (ESD) $\pm 30kV$ (air), $\pm 30kV$ (contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 120A (8/20 μs)

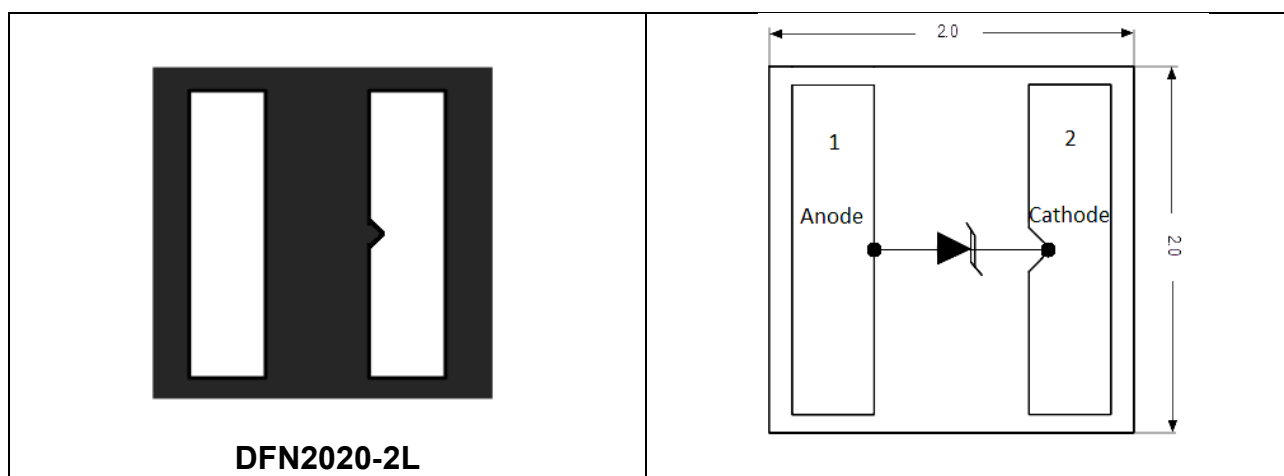
Mechanical Characteristics

- DFN2020-2L package
- Molding compound flammability rating:
UL 94V-0
- Packaging: Tape and Reel
- RoHS Compliant

Applications

- I/O Interfaces
- Power lines
- Automotive and Telecommunication
- Computer & Consumer Electronics
- Industrial Electronics
- Microcontroller Input Protection

Schematic & PIN Configuration



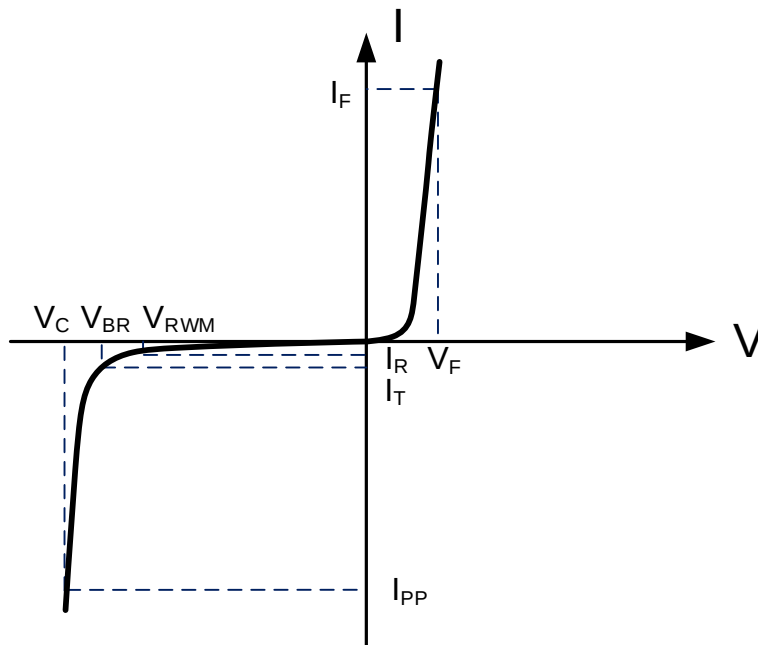
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Absolute Maximum Rating

Parameter	Symbol	Value	Unit
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{PP}	6000	Watts
Peak Pulse Current ($t_p = 8/20\mu s$)	I_{PP}	120	A
Power Dissipation	P_D	800	mW
Operating Temperature	T_J	-55 to + 125	°C
Storage Temperature	T_{STG}	-55 to +150	°C

Electrical Parameters (T=25°C)

Symbol	Parameter
I_{PP}	Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Reverse Stand-Off Voltage
I_R	Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_F	Forward Current
V_F	Forward Voltage @ I_F



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Electrical Characteristics(T=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse Stand-Off Voltage	V_{RWM}				26.0	V
Reverse Breakdown Voltage	V_{BR}	$I_T=1mA$	28		30.5	V
Forward Voltage	V_F	$I_F=10mA$	0.4		1.0	V
Reverse Leakage Current	I_R	$V_{RWM}=26V$, $T=25^{\circ}C$			500	nA
Clamping Voltage ⁽³⁾	V_C	$I_{PP}=120A$, $t_p=8/20\mu s$		49.0		V
Dynamic Resistance ^{(1) (2) (3)}	R_{DYN}	$TLP=0.2/100ns$		0.06		Ω
Junction Capacitance ⁽³⁾	C_j	$V_R = 0V$, $f = 1MHz$		700		pF

Note1.TLP Setting: $t_p=100ns$, $t_r=0.2ns$, I_{TLP} and V_{TLP} sample window: $t_1=70ns$ to $t_2=90ns$.

Note2.Dynamic resistance calculated from $I_{PP}=4A$ to $I_{PP}=16A$ using “Best Fit”.

Note3.These specifications are guaranteed by design and characterization. Not FT item.

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Typical Characteristics

Figure 1: Peak Pulse Power vs. Pulse Time

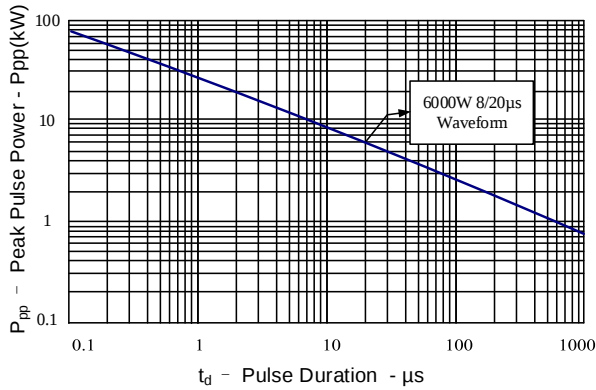


Figure 2: Power Derating Curve

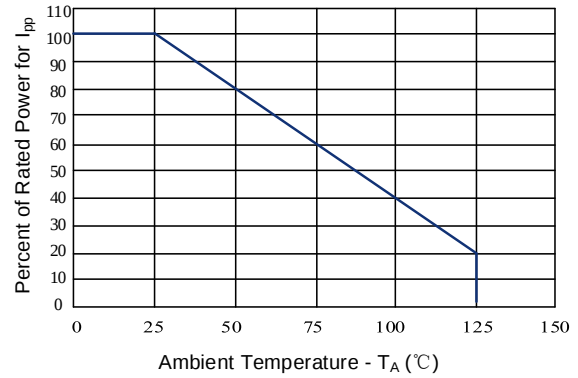


Figure 3: Clamping Voltage vs. Peak Pulse Current

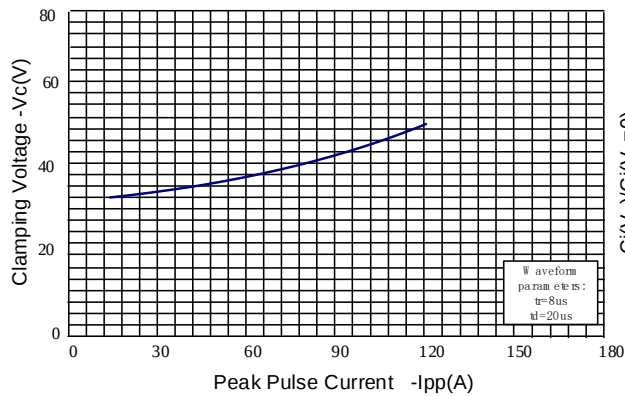


Figure 4: Normalized Junction Capacitance vs. Reverse Voltage

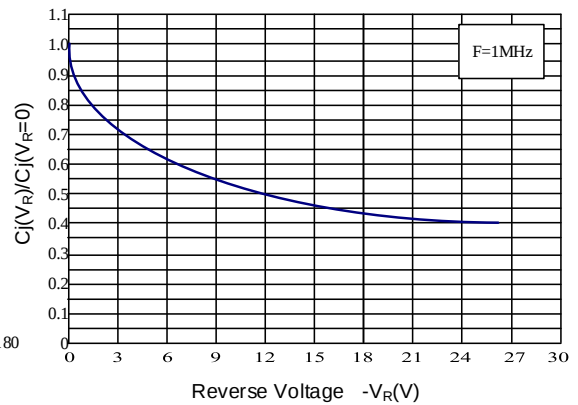


Figure 5: 8/20 μs Pulse Waveform

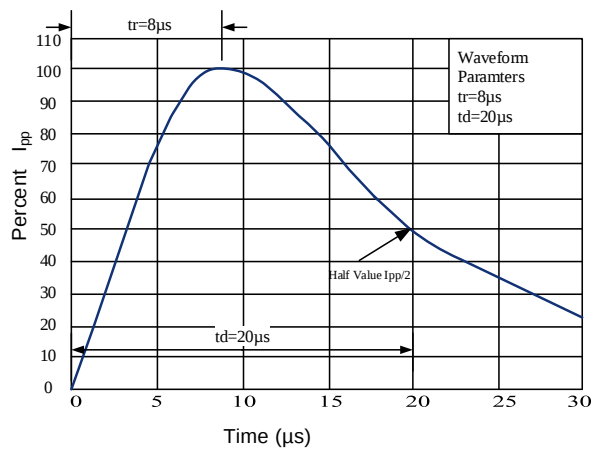
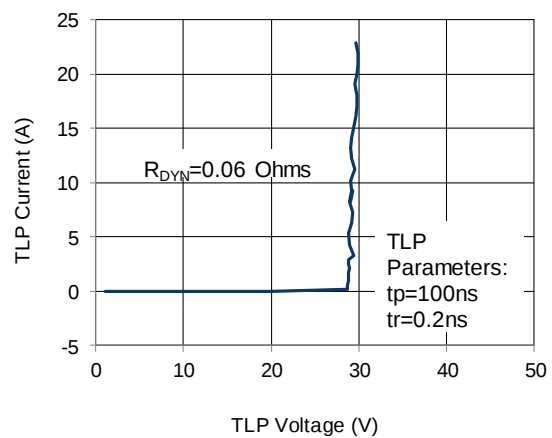


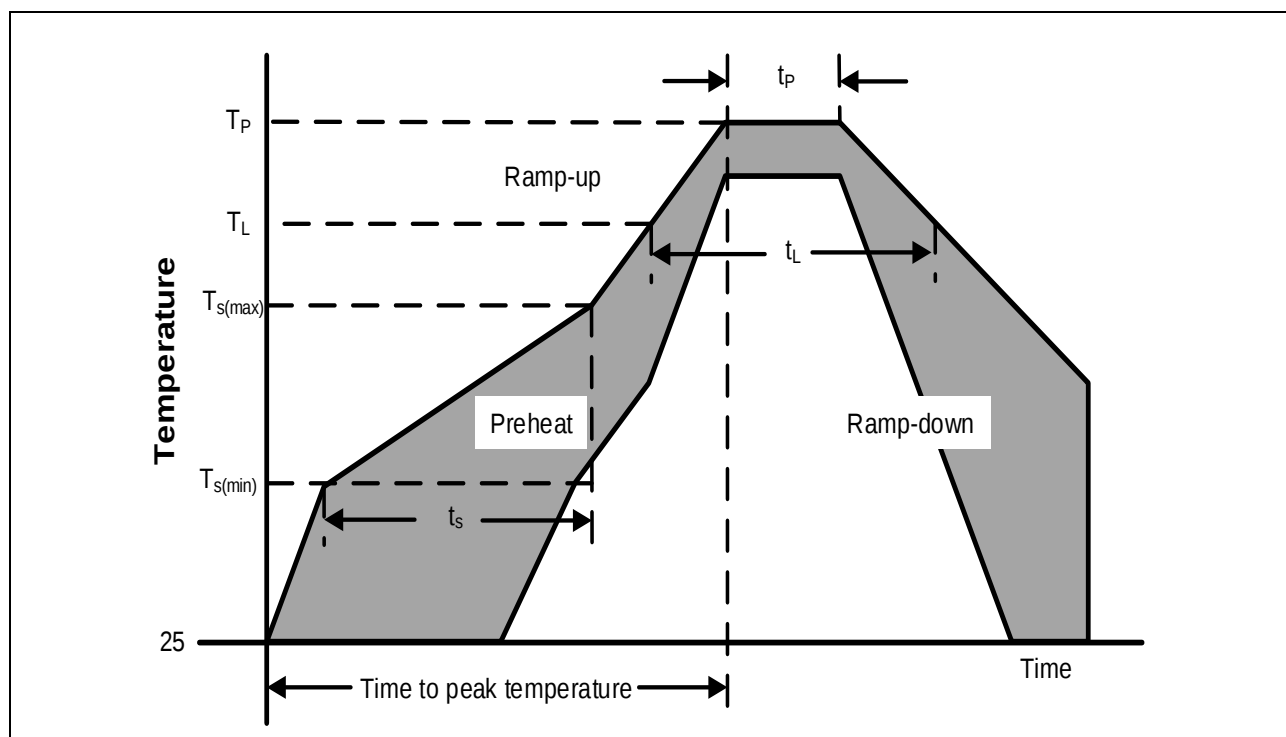
Figure 6: TLP I-V Curve



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Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	Temperature Min ($T_{S(min)}$)	150°C
	Temperature Max ($T_{S(max)}$)	200°C
	Time (min to max) (t_s)	60 – 190 secs
Average ramp up rate (Liquidus Temp) (T_L) to peak		5°C/second max
$T_{S(max)}$ to T_L ——Ramp-up Rate		5°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_P)		260+0/-5 °C
Time within actual peak Temperature (t_P)		20 – 40 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature (T_P)		8 minutes Max.
Do not exceed		280°C



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Package Dimension

PACKAGE OUTLINE

Top view diagram showing dimensions D (total width), E (total height), and 1 (pitch between pads).

TOP VIEW

Bottom view diagram showing dimensions L (total length), b (pad width), c (pitch between pads), and X (lead length). It also indicates the Cathode Mark.

BOTTOM VIEW

Side view diagram showing dimensions A (total thickness), A1 (lead thickness), and c (lead height).

SIDE VIEW

DFN2020-2L package symbol showing the package footprint and pin configuration.

DFN2020-2L

SYMBOL	MILLIMETERS		
	MIN	NOM	MAX
A	0.50	0.55	0.60
A1	0.00	0.02	0.05
b	0.35	0.45	0.55
c	0.152REF		
D	1.90	2.00	2.10
e	1.35BSC		
E	1.90	2.00	2.10
L	1.70	1.80	1.90
X	-	0.12	-
Y	-	0.24	-

Ordering Information

Part	Package	Marking	Packing Information
ES26P4NA	DFN2020-2L	Cathode  Anode N26A=Specific Device Code XXXX=Tracking number	3k/Reel

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Revision History and Checking Table

Version	Date	Revision Item	Modifier	Function & Spec Checking	Package & Tape Checking
1.0	2017-07-11	Preliminary Version	Liu Jia Ying	Qi Shu Kun	Liu Jia Ying
1.1	2017-07-31	Update package dimension	Liu Jia Ying	Qi Shu Kun	Liu Jia Ying
1.2	2017-08-29	Updated PIN1 for Anode PIN2 for Cathode	Liu Jia Ying	Qi Shu Kun	Liu Jia Ying
1.3	2017-09-23	Adjust VBR after data statistics	Liu Jia Ying	Qi Shu Kun	Liu Jia Ying
1.4	2017-09-28	Adjust VBR spec	Liu Jia Ying	Qi Shu Kun	Liu Jia Ying
1.5	2023-08-28	Update Typeset	Yin Peng	Qi Shu Kun	Liu Jia Ying